

SP	PECIFICATIONS	
CUSTOMER	:	
SAMPLE CODE	SH800480T02	7-ZHA
MASS PRODUCTION CODE	PH800480T02	7-ZHA
SAMPLE VERSION	·	
SPECIFICATIONS EDITION	. 002	
DRAWING NO. (Ver.)	· . LMD-PH80048	80T027-ZHA (Ver.002)
PACKAGING NO. (Ver.)		
()	·	
Cus	tomer Approved	
		Date:
Approved	Checked	Date: Designer
	Checked	Designer
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林裘中 Daniel Lin Preliminary specification for Specification for sample app POW adguarters:	Checked 廖志豪 Rex Liao design input proval	Designer 張慶源 Yuan Chang
林裘中 Daniel Lin ■ Preliminary specification for □ Specification for sample app POW	Checked 廖志豪 Rex Liao design input proval	Designer 張慶源 Yuan Chang 2018. Twre 68 E-mail: <u>sales@powertip.com</u>



# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
06/06/2018	01	001	New Drawing.		Yuan
08/13/2018	01	002	Modify Mechanical Specifications Modify Optical Characteristics Modify Backlight Characteristics Modify Interface Pin Description Modify LCM Design	4 7 9 12 Appendix	Yuan
				т	otal: 25 Page
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# Contents

# **1. SPECIFICATIONS**

- 1.1 Features
- 1.2 Mechanical Specifications
- **1.3 Absolute Maximum Ratings**
- **1.4 DC Electrical Characteristics**
- 1.5 Optical Characteristics
- **1.6 Backlight Characteristics**

# 2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

# **3. QUALITY ASSURANCE SYSTEM**

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

## **4. RELIABILITY TEST**

4.1 Reliability Test Condition

# **5. PRECAUTION RELATING PRODUCT HANDLING**

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

## **Appendix :**

1. LCM drawing.



# 1. SPECIFICATIONS

## 1.1 Features

Standard Value
800 * (RGB) * 480
IPS , Normally Black , Transmissive type
7.0 inch
Hard Coating
RGB-stripe
LED B/L
24 Bits RGB Interface
THIS PRODUCT CONFORMS THE ROHS OF PTC
Detail information please refer website :
http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

# **1.2 Mechanical Specifications**

Item	Standard Value	Unit
Outline Dimension	167.7(W) * 109.45 (L) * 19.8 (H)	mm

## LCD panel

Item	Standard Value	Unit
Active Area	152.4 (W) * 91.44 (L)	mm

Note : For detailed information please refer to LCM drawing



## 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
	Vdd		3	3.6	V	
	AVdd	GND=0	12.85	13.5	V	
Power Supply Voltage	V <sub>GH</sub>		-0.3	40	V	-
	V <sub>GL</sub>	AGND=0	-20	0.3	V	
	V <sub>GH</sub> - V <sub>GL</sub>	-	0	40	V	
Operating Temperature	Тор	-	-30	+85	°C	(1)(2)(3)(4)
Storage Temperature	Tst	-	-40	+90	°C	(1)(2)(3)(4)

Note (1) (a) 90 %RH Max. (Ta  $\leq 40 \ ^{\circ}C$ ).

(b) Wet-bulb temperature should be 39  $^{\circ}$ C Max. (Ta > 40  $^{\circ}$ C).

(c) No condensation.

Note (2) Ta = Ambient Temperature, Tp = Panel Surface Temperature.

- Note (3) This rating applies to all parts of the module and should not be exceeded.
- Note (4) If the product were used out of the operation and storage range, it will have quality issue.

## 1.4 DC Electrical Characteristics

GND = 0V, Ta = 25 ℃

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
	Vdd	3.0	3.3	3.6		
Supply Voltage	Vgн	25	26	27	v	
Supply Voltage	VGL	-7.14	-7.07	-7.0	V	
	AVDD	12.9	13.2	13.5		-
VCOM	Vсом	-	-	-	۷	
	Vін	0.7Vdd	-	Vdd		
Input signal Voltage	VIL	0	-	0.3Vdd	V	
Supply Current	IVDD	-	(90)	=	mA	-



# **1.5 Optical Characteristics**

## **TFT LCD Module**

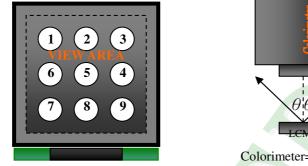
V<sub>DD</sub> = 3.3 V, Ta=25 ℃

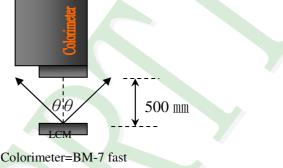
							0.0 4, 1	
ltem		Symbol	Condition	Min.	Тур.	Max.	unit	
Response time		Tr+Tf	Ta = 25 ℃ θX, θY = 0°	-	30	45	ms	Note 2
	Тор	θY+		70	80	-		
Viewing angle	Bottom	θY-	CR ≥ 10	70	80	-	Deg.	Note 4
viewing angle	Left	θX-		70	80	-	Dey.	NOLE 4
	Right	θX+		70	80	-		
Contrast ratio	1	CR		600	800	-		Note 3
	White	Х			-	-		
	vvnite	Y		-	-	-		
Color of CIE	Red	Х	T- 0500	ŀ	-	-		
Color of CIE Coordinate	neu	Y	Ta = 25 ℃ θX , θY = 0°	1	1	-		Note1
(With B/L)	Green	Х		-	-	-	-	NOLET
	Green	Y			-	-		
	Blue	Х		1	-	-		
	Diue	Y		1	-	-		
Average Brightne	ess							
Pattern=white dis	play	IV	IL = (160) mA	-	(1000)	-	cd/m2	Note1
(With B/L) *	1							
Uniformity (With B/L)*	2	∆B	IL =(160) mA	70	-	-	%	Note1



Note 1:

- \*1 : △B=B(min) / B(max) \* 100%
- \*2 : Measurement Condition for Optical Characteristics:
  - a : Environment: 25°C ±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance: 500  $\pm$  50  $\,{\rm mm}^{-}$  , (0= 0 °)
  - c: Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

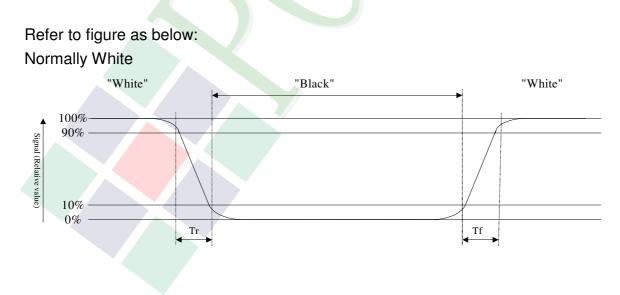




To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

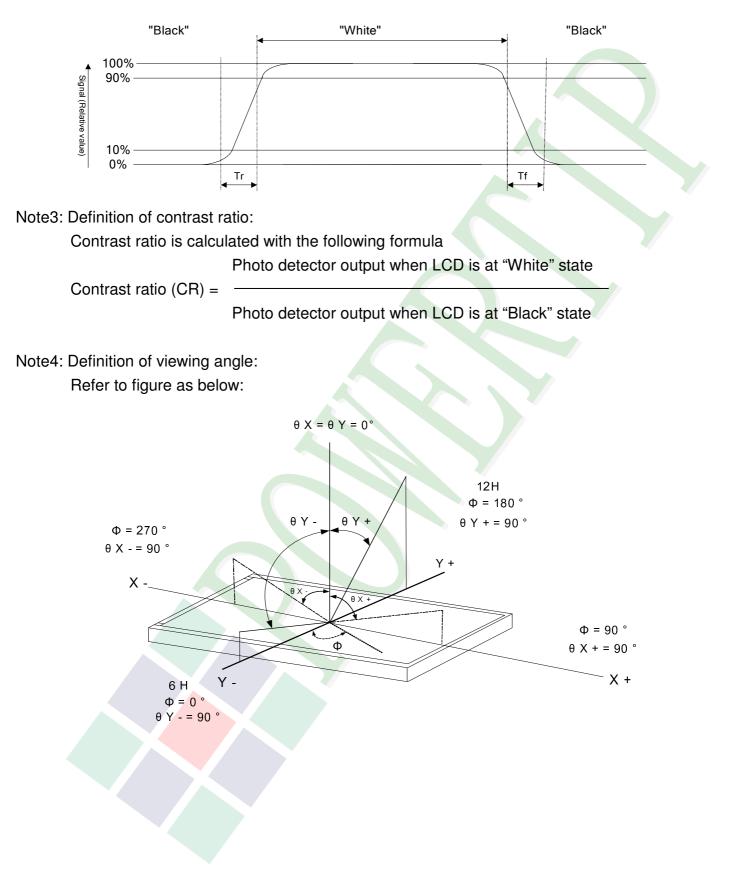
Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.





Normally Black





## **1.6 Backlight Characteristics**

Maximum Ratings

ltem	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	<b>Ta =25</b> ℃	-	-	mA
LED Reverse Voltage	VR	<b>Ta =25</b> ℃	-	(5)	V
Power Dissipation	PD	<b>Ta =25</b> ℃	-	-	W

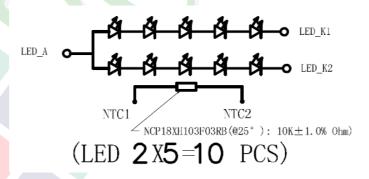
#### **Backlight Characteristics**

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF			(15.0)	-	V
Average Brightness (Without LCD)	IV	IE (160) mA	-	(8500)	<b>Y</b> -	cd/m <sup>2</sup>
CIE Color Coordinate	Х	IF= (160) mA		(0.295)	-	
(Without LCD)	Y		-	(0.264)	-	-
Uniformity *1	∆B		75	-	-	*2
Color			White			

\*1 : This value will be changed while mass production.

## \*2: △B=B(min) / B(max)%

B/L Internal Circuit Diagram



Other Description		
Item	Conditions	Description
Life Time	Ta =25℃	50000 hrs
	IF= (160)mA	



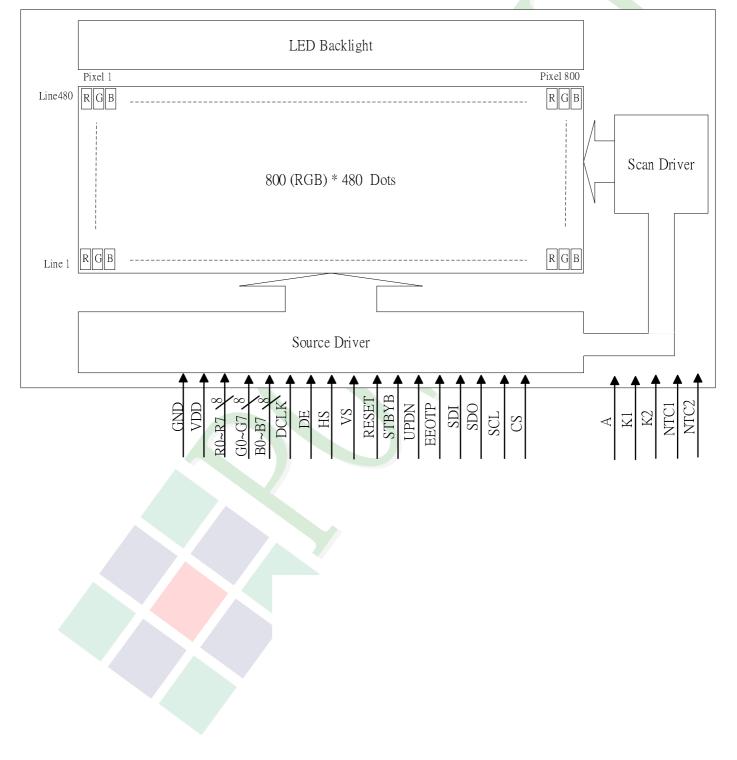
# 2. MODULE STRUCTURE

## 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

\* See Appendix

### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

# **TFT LCM Interface**

Pin NO.	SYMBOL	DESCRIPTION
1	GND	Power ground.
2	NC	No Connection
3	V <sub>DD</sub>	Power for Digital Circuit.
4	R0	Red Data(LSB).
5	R1	Red Data.
6	R2	Red Data.
7	R3	Red Data.
8	R4	Red Data.
9	R5	Red Data.
10	R6	Red Data.
11	R7	Red Data(MSB).
12	G0	Green Data(LSB).
13	G1	Green Data.
14	G2	Green Data.
15	G3	Green Data.
16	G4	Green Data.
17	G5	Green Data.
18	G6	Green Data.
19	G7	Green Data(MSB).
20	B0	Blue Data(LSB).
21	B1	Blue Data.
22	B2	Blue Data.
23	B3	Blue Data.
24	B4	Blue Data.
25	B5	Blue Data.
26	B6	Blue Data.
27	B7	Blue Data(MSB).
28	DCLK	Clock signal
29	DE	Data Input Enable.
30	HS	Horizontal Sync Input.
31	VS	Vertical Sync Input.
32	NC	No Connection
33	RESET	Global reset pin.
34	STBYB	Standby mode
35	SHLR	Horizontal scan direction



Pin NO.	SYMBOL	DESCRIPTION				
36	Vdd	Power for Digital Circuit.				
37	UPDN	Vertical scan direction				
38	GND	Power Ground				
39	GND	Power Ground.				
40	NC	No connection.				
41	NC	No connection.				
42	NC	No connection.				
43	NC	No connection.				
44	NC	No connection.				
45	NC	No connection.				
46	NC	No connection.				
47	NC	No connection.				
48	NC	No connection.				
49	EEOTP	Apply 6.65V to OTP				
50	NC	No connection.				
51	SDI	Serial data input of SPI				
52	SDO	Serial data output of SPI				
53	SCL	Clock signal of SPI				
54	CS	Slaver select				
55	NC	No connection.				
56	NC	No connection.				
57	V <sub>DD</sub>	Power for Digital Circuit.				
58	NC	No connection.				
59	GND	Power Ground.				
60	NC	No connection.				

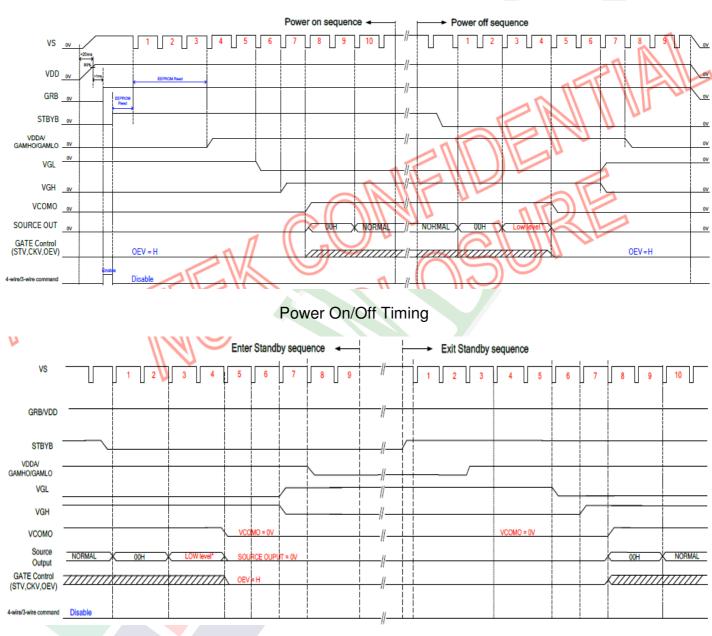
# FPC1 interface (LED Backlight)

Pin No.	Symbol	Function
1	A	LED Backlight anode input
2	K1	LED Backlight for cathode input
3	K2	LED Backlight for cathode input
4	NC	No Connection
5	NTC1	Thermistor
6	NTC2	Thermistor



## 2.3 Timing Characteristics 2.3.1 POWER ON/OFF TIMING SEQUENCE

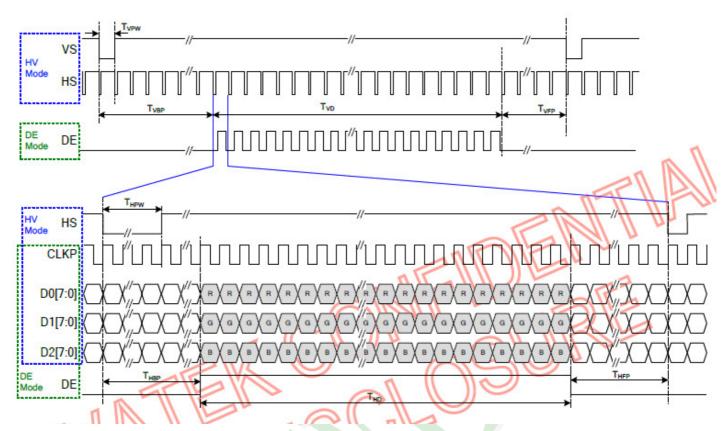
The recommended sequence should be:Digital power(VDD, GND)  $\rightarrow$  Logic signals $\rightarrow$ Analog power(VDD, GND) & Gamma correction reference voltage(GMAH, GMAL).To shut down, reverse this sequence, or turn off all signals and power simultaneously.



Enter/Exit Standby Mode



## 2.3.2 INPUT CHARACTERISTICS FOR TTL MODE SIGNALS



#### HV mode for 800x480

Parameter	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	FCLK	25.2	25.4	35.7	MHz
Horizontal display area	THD		800		CLK
HS period time		860	864	974	CLK
HS pulse width	T <sub>HPW</sub>	1	2	40	CLK
HS back porch	T <sub>HBP</sub>		32		CLK
HS front porch	T <sub>HFP</sub>	28	32	142	CLK
Vertical display area	T <sub>VD</sub>		480		Н
VS period time	Tv	488	490	611	Н
VS pulse width	T <sub>VPW</sub>	1	2	20	Н
VS back porch	T <sub>VBP</sub>		5		Н
VS front porch	T <sub>VFP</sub>	3	5	126	Н

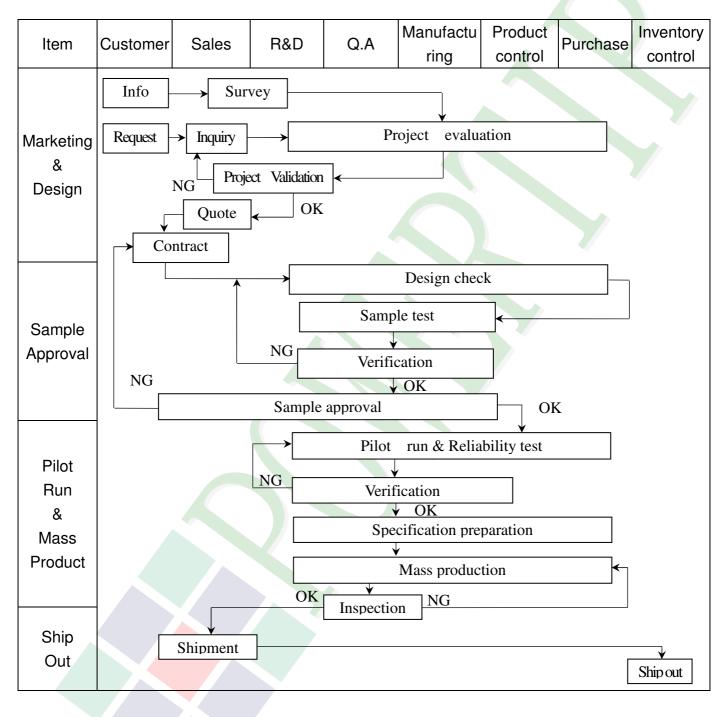
#### DE mode for 800x480

Parameter	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	F <sub>CLK</sub>	25.2	25.4	35.7	MHz
Horizontal display area	T <sub>HD</sub>		800	•	CLK
HS period time	T <sub>H</sub>	860	864	974	CLK
HS blanking	T <sub>HFP</sub> + T <sub>HBP</sub>	60	64	174	CLK
Vertical display area	T <sub>VD</sub>		480		Н
VS period time	Tv	488	490	611	Н
VS blanking	T <sub>VBP</sub> + T <sub>VFP</sub>	8	10	131	Н



# **3. QUALITY ASSURANCE SYSTEM**

## 3.1 Quality Assurance Flow Chart





Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info Analys	Claim	[	Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrati	on	4	Process in . Education			es

# **POWERTIP**

## **3.2. Inspection Specification**

Scope : The document shall be applied to TFT-LCD Module for 3. 5" ~10" (Ver.B01).

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5

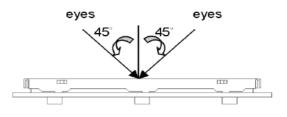
♦OUT Going Defect Level : Sampling.

◆Standard of the product appearance test ∶

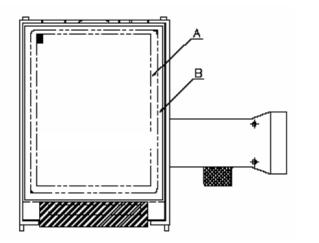
a. Manner of appearance test :

(1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.

(2). The test direction is base on about around  $45^\circ$  of vertical line.



#### (3). Definition of area.



A area : viewing area

**B** area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



#### ◆Specification For TFT-LCD Module 3. 5″~10″:

♦Spe	cification For TFT-L	CD Modu	ıle 3. 5″	~10":		(Ver.B01)	
NO	Item	Criterion				Level	
			1. 1The part number is inconsistent with work order of production.				
01	Product condition	1. 2 Mix	ed produ	uct types.		Major	
		1. 3 Asse	embled i	n inverse direction.		Major	
02	Quantity	2. 1The	quantity	is inconsistent witl	h work order of production.	Major	
03	Outline dimension		duct din gram.	nension and struct	ure must conform to structur	e Major	
		4.1 Mis	4. 1 Missing line character and icon.				
		4. 2 No function or no display.					
04	Electrical Testing	4. 3 Disp	4. 3 Display malfunction.				
		4.4 LC	D viewir	ng angle defect.		Major	
		4. 5 Cur	rent con	sumption exceeds <b>p</b>	product specifications.	Major	
		Г		<b>-</b> .			
				Item	Acceptance (Q'ty)		
	Dot defect		-	Bright Dot	≦ 4		
			Dot	Dark Dot	≦ 5		
	(Bright dot 、		Defect	Joint Dot	≦ 3		
05	Dark dot)			Total	≦ 7	Minor	
	On -display	5. 1 Insj	pection ]	pattern : full white	, full black , Red , Green an	d	
			_	blue screen			
					ect area $>1/2$ dot.		
		5. 3 The	distance	e between two dot d	lefect $\geq 5$ mm.		



<b>♦</b> Speci	fication For TFT-L	CD Module 3. 5″	~10″:				(Ver.B01)
NO	Item		Cri	terion			Level
		6. 1 Round type	( Non-display or	display)	:		
		Dimensio	n (diameter : Ф)	)	ceptance		
	Black or white			A ai	rea	B area	
	dot、scratch、		$\Phi \leq 0.25$	Ign	ore		
	contamination	0.25	$< \Phi \leq 0.50$	5	i	Imara	
	Round type		$\Phi~>~0.50$	0		Ignore	
	$\rightarrow$ X $\leftarrow$ Y		Total	5	;		
06	$\Phi = (x+y)/2$	6. 2 Line type( N	on-display or di	splay):			Minor
				<b>T</b> D	Accept	tance (Q'ty)	
	Line type	Length (L)	Width (N	w)	A area	a Barea	
	⊂ /¥w		W	$\leq 0.03$	Ignor	e	
		L ≦10.0	$0.03 < W \leq$	≦ 0.05	4		
		L ≦5.0	0.05 < W =	<b>≦ 0.1</b> 0	2	Ignore	
			W	>0.10	As roun type	nd	
			Total		5		
				٨٥	ceptance	( <b>0</b> 'tv)	
		Dimension (	diameter∶Φ) -	A ar		B area	
			$\Phi \leq 0.25$	Igno	ore		
07	Polarizer	0.25 <	$\Phi \leq 0.50$	4			Minor
	Bubble	0.50 <	$\Phi \leq 0.80$	1		Ignore	
			$\Phi > 0.80$	0			
		Te	otal	5			



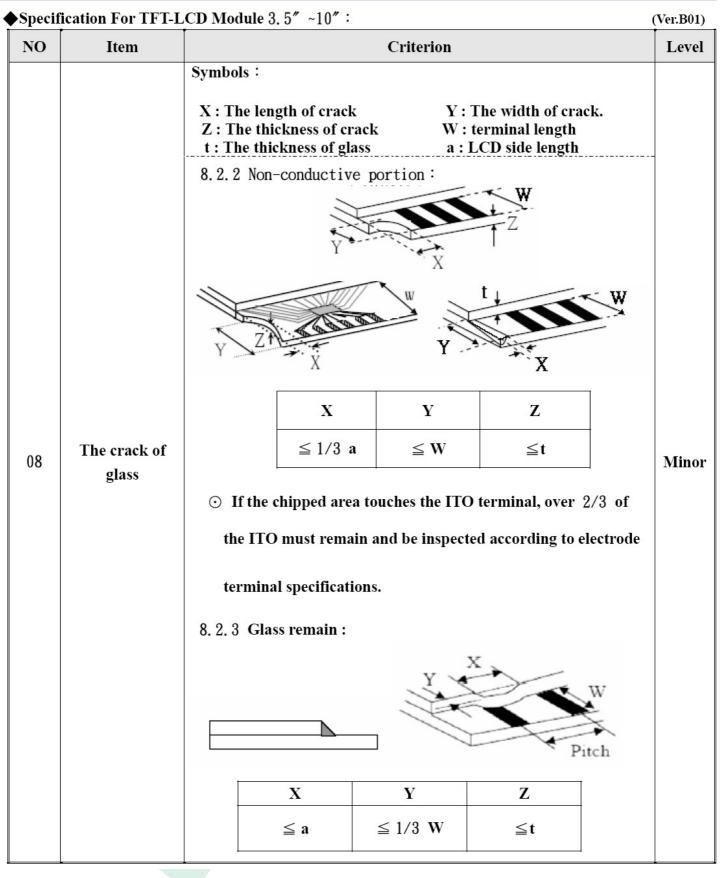
#### ◆Specification For TFT-LCD Module 3. 5″ ~10″:

NO				
	Item	Criterion		Level
08	Item The crack of glass	Symbols : X : The length of crack Z : The thickness of crack	Y: The width of crack. Y: terminal length a: LCD side length ck between panels: $V \rightarrow V$ $V \rightarrow V$ $V \rightarrow V$ $V \rightarrow V$ $V \rightarrow V$ $V \rightarrow V$ $V \rightarrow V$	Level
		≤ a Crack can't enter viewing area	$\leq 1/2 t$	
		$\leq a \qquad \begin{array}{c} Crack \ can't \ exceed \ the \\ half \ of \ SP \ width. \end{array}$	$1/2 t < Z \leq t$	



♦Specifi	Specification For TFT-LCD Module 3. 5″~10″: (Ver.B					
NO	Item	Criterion				
		Z : The thi t : The thi	ngth of crack ickness of crack ckness of glass ner crack :	Y : The width W : terminal le a : LCD side le	ength	
		X	Y	Z		
		$\leq 1/5$ a	Crack can't enter viewing area	$\mathbf{Z} \leq 1$	/2 t	
		$\leq 1/5$ a	Crack can't exceed half of SP width.		$\leq 2 t$	
08	The crack of glass	$ \begin{array}{ c c c c c } \hline \leq 1/5 & a & Crack can't exceed the half of SP width. \\ \hline 1/2 & t < Z & \leq 2 & t \\ \hline 8.2 & Protrusion over terminal : \\ \hline 8.2.1 & Chip on electrode pad : \\ \hline & & & & \\ \hline & & & & \\ \hline & & & & \\ \hline & & & &$				
		Back	≦ a	≦ W :	$\leq 1/2 t$	







# 4. RELIABILITY TEST

# 4.1 Reliability Test Condition

(Ver.A01)

<b>-7</b> .1	Tienability Test Co		(Vei.AUI)			
NO.	TEST ITEM	TEST CO	ONDITION			
1	High Temperature Storage Test	Keep in 90 ±5℃ 500 hrs Surrounding temperature, then st	orage at normal condition 4hrs.			
2	High Temperature Operating Test	Keep in 85 ±5°C 500 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	Low Temperature Storage Test	Keep in−40 ±5°C 500 hrs Surrounding temperature, then storage at normal condition 4hrs.				
4	Low Temperature Operating Test	Keep in −30 ±5°C 500 hrs Surrounding temperature, then st	orage at normal condition 4hrs.			
5	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 500 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
6	High Temperature / High Humidity Operating Test	Keep in +60℃ / 90% R.H duration for 500 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
7	Temperature Cycling Storage Test	(30mins) (5mins)	$\rightarrow 90^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) Cycle orage at normal condition 4hrs.			
8	Temperature Cycling Operating Test	$-30^{\circ}C \rightarrow +25^{\circ}C \rightarrow (30^{\circ}mins) (5^{\circ}mins) \\ 4 25^{\circ}C \\ 5 4 25^{\circ$	(30mins) (5mins) Cycle			
9	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15°C - 2. Humidity relative : 30% ~60% 3. Energy Storage Capacitance(C 4. Discharge Resistance(Rd) : 330 5. Discharge, mode of operation : Single Discharge (time between so (Tolerance if the output voltage in	% Cs+Cd):150pF±10% 0Ω±10% successive discharges at least 1 sec)			
10	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequence</li> <li>The amplitude of vibration :1.</li> <li>Each direction (X ⋅ Y ⋅ Z) due</li> </ol>	5 mm			



			Packing Weight (Kg)	Drop Height (cm)
		0 ~ 45.4	122	
11	1 Drop Test		45.4 ~ 90.8	76
	(Packaged)		90.8 ~ 454	61
			Over 454	46
		Drop Direct	ion : ※1 corner / 3 edges	/ 6 sides each 1 time

#### **©Result Evaluation Criteria :**

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function. (Normal operation state)

Temperature : +20~30°C Humidity : 50~70% Atmospheric pressure : 86~106Kpa



# **5. PRECAUTION RELATING PRODUCT HANDLING**

## 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

# 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

# 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

## 5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

